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Date of Deposit: March 15, 2004

Siemens No. 2003P19702US
(BHGL Case No.: 12300/10)

IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

In re Application of:

Park et al.

Examiner: Unassigned

Serial No.: TBD

Group Art Unit No.: Unassigned

Filing Date: Herewith

For: SYSTEM AND METHOD FOR
ACTIVELY COOLING
TRANSDUCER ASSEMBLY
ELECTRONICS

INFORMATION DISCLOSURE STATEMENT

Commissioner for Patents
Alexandria, VA 22313-1450

Dear Sir:

In compliance with the duty of disclosure under 37 C.F.R. § 1.56, it is respectfully requested that this Information Disclosure Statement be entered and the documents listed below and on the attached Form PTO-1449 be considered by the Examiner and made of record. Copies of the listed documents required by 37 C.F.R. § 1.98(a)(2) are enclosed for the convenience of the Examiner.

The references now cited are the following:

| DOCUMENT NUMBER <small>Number-Kind Code (if known)</small> | DATE | NAME |
|--|-------------|--------------------|
| 4,567,895 | 02/04/86 | Putzke |
| 5,545,942 | 08/13/96 | Jaster et al. |
| 5,560,362 | 10/01/96 | Sliwa, Jr., et al. |
| 5,690,114 | 11/25/97 | Chiang et al. |
| 5,721,463 | 02/24/98 | Snyder |
| 5,882,310 | 03/16/99 | Marian, Jr. |

| | | |
|--|----------|-------------------|
| 5,961,465 | 10/05/99 | Kelly, Jr. et al. |
| 6,050,943 | 04/18/00 | Slayton et al. |
| 6,142,947 | 11/07/00 | Tran et al. |
| 6,433,464 B2 | 08/13/02 | Jones |
| 6,605,043 B1 | 08/12/03 | Dreschel et al. |
| 6,669,638 B1 | 12/30/03 | Miller et al. |
| <p align="center">OTHER ART – NON PATENT LITERATURE DOCUMENTS</p> <p>(Include name of author, title of the article (when appropriate), title of the item (book, magazine, journal, serial, symposium, catalog, etc.), date page(s), volume-issue number(s), publisher, city and/or country where published.</p> | | |
| <p>Robert E. Simons, electronics cooling applications article "Electronics Cooling: Direct liquid immersion cooling for high power density microelectronics" obtained at http://www.electronics-cooling.com/Resources/EC_Articles/May96/may96_04.htm, pp. 1-9, 2/13/04</p> | | |

In accordance with 37 C.F.R. § 1.97(g),(h), this Information Disclosure Statement is not to be construed as a representation that a search has been made and is not to be construed to be an admission that the information cited is, or is considered to be, material to patentability as defined in 37 C.F.R. § 1.56(b).

This Information Disclosure Statement is being filed prior to the receipt of the first Official Action reflecting an examination on the merits and hence is believed to be timely filed in accordance with 37 C.F.R. § 1.97(b). No fees are believed to be due in connection with filing of this Information Disclosure Statement, however, should any fees under 37 C.F.R. §§ 1.16 to 1.21 be deemed necessary for any reason relating to these materials, the Commissioner is hereby authorized to deduct said fees from Brinks Hofer Gilson & Lione Deposit Account No. 23-1925. A duplicate copy of this document is enclosed.

Applicant(s) respectfully request that the listed documents be made of record in the present case.

Respectfully submitted,



James L. Katz
Registration No. 42,711
Attorney for Applicant(s)

BRINKS HOFER GILSON & LIONE
P.O. Box 10395
Chicago, IL 60610
(312) 321-4200

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| FORM PTO-1449 | SERIAL NO. TBD | Siemens Ref. No. 2003P19702US (BHGL CASE NO. 12300/10) |
| LIST OF PATENTS AND PUBLICATIONS FOR APPLICANT'S INFORMATION DISCLOSURE STATEMENT (use several sheets if necessary) | FILING DATE Herewith | GROUP ART UNIT TBD |
| APPLICANT(S): Park et al. | | |

REFERENCE DESIGNATION
U.S. PATENT DOCUMENTS

| EXAMINER INITIAL | | DOCUMENT NUMBER <small>Number-Kind Code (if known)</small> | DATE | NAME | CLASS/ SUBCLASS | FILING DATE |
|---------------------|-----|--|----------|--------------------|--------------------|----------------|
| | A1 | 4,567,895 | 02/04/86 | Putzke | 128/660 | 04/02/84 |
| | A2 | 5,545,942 | 08/13/96 | Jaster et al. | 310/341 | 11/21/94 |
| | A3 | 5,560,362 | 10/01/96 | Sliwa, Jr., et al. | 128/660.03 | 06/13/94 |
| | A4 | 5,690,114 | 11/25/97 | Chiang et al. | 128/661.01 | 02/12/96 |
| | A5 | 5,721,463 | 02/24/98 | Snyder | 310/334 | 12/29/95 |
| | A6 | 5,882,310 | 03/16/99 | Marian, Jr. | 600/459 | 12/01/97 |
| | A7 | 5,961,465 | 10/05/99 | Kelly, Jr. et al. | 600/459 | 02/10/98 |
| | A8 | 6,050,943 | 04/18/00 | Slayton et al. | 600/439 | 10/14/97 |
| | A9 | 6,142,947 | 11/07/00 | Tran et al. | 600/459 | 12/04/98 |
| | A10 | 6,433,464 B2 | 08/13/02 | Jones | 310/328 | 08/31/01 |
| | A11 | 6,605,043 B1 | 08/12/03 | Dreschel et al. | 600/459 | 12/30/98 |
| | A12 | 6,669,638 B1 | 12/30/03 | Miller et al. | 600/438 | 10/10/02 |

FOREIGN PATENT DOCUMENTS

| EXAMINER INITIAL | | DOCUMENT NUMBER <small>Number-Kind Code (if known)</small> | DATE | COUNTRY | CLASS/ SUBCLASS | TRANSLATION YES OR NO |
|---------------------|--|--|------|---------|--------------------|--------------------------|
| | | | | | | |

| EXAMINER INITIAL | OTHER ART – NON PATENT LITERATURE DOCUMENTS (Include name of author, title of the article (when appropriate), title of the item (book, magazine, journal, serial, symposium, catalog, etc.), date page(s), volume-issue number(s), publisher, city and/or country where published. | |
|---------------------|---|---|
| | A13 | Robert E. Simons, electronics cooling applications article "Electronics Cooling: Direct liquid immersion cooling for high power density microelectronics" obtained at http://www.electronics-cooling.com/Resources/EC_Articles/May96/may96_04.htm , pp. 1-9, 2/13/04. |

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|----------|-----------------|
| EXAMINER | DATE CONSIDERED |
|----------|-----------------|

EXAMINER: Initial if reference considered, whether or not citation is in conformance with MPEP 609; Draw line through citation if not in conformance and not considered. Include copy of this form with next communication to applicant.